### Si2342DS

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8

0.017

0.020

0.022

0.030

0.075

6

6

Single

#### SOT-23 (TO-236)

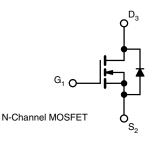
#### **FEATURES**

N-Channel 8 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- · Low on-resistance
- 100 % R<sub>q</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Load switches for low voltage gate drive
- Low voltage operating circuits - Gate drive 1.2 V to 5 V



#### **ORDERING INFORMATION**

Marking code: F2

V<sub>DS</sub> (V)

Q<sub>g</sub> typ. (nC)

Configuration

I<sub>D</sub> (A) a, e

**PRODUCT SUMMARY** 

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 4.5 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 2.5 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 1.8 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 1.5 V

 $R_{DS(on)} \overline{max.} (\Omega) \text{ at } V_{GS} = 1.2 \text{ V}$ 

•				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2342DS-T1-GE3			

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, u	inless otherwi	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	8	N	
Gate-source voltage		V <sub>GS</sub>	± 5	V	
	T <sub>C</sub> = 25 °C		6 <sup>e</sup>		
Continuous durin surrent (T 150 °C)	T <sub>C</sub> = 70 °C	Т. Г	6 <sup>e</sup>		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	6 b, c, e		
	T <sub>A</sub> = 70 °C	1	5.8 <sup>b, c</sup>	A	
Pulsed drain current (t = 300 µs)		I <sub>DM</sub>	30		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		2.1		
	T <sub>A</sub> = 25 °C	Is –	1.1 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		2.5		
Maximum power dissipation	T <sub>C</sub> = 70 °C		1.6	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.3 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature)			260	-0	

#### THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R <sub>thJA</sub>	75	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	40	50	-0/w	

#### Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 sd. Maximum under steady state conditions is 166 °C/W

e. Package limited

S11-1388-Rev. A, 11-Jul-11

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Document Number: 63302



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	8	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 250 4	-	10	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-2.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.35	-	0.8	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 5 V$	-	-	± 100	nA	
Zara gata valtaga drain ourrant		$V_{DS} = 8 V, V_{GS} = 0 V$	-	-	1		
Zero gate voltage drain current	IDSS	$V_{DS}$ = 8 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	10	μΑ	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	20	-	-	Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7.2 \text{ A}$	-	0.014	0.017		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}$	-	0.016	0.020	1	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 6.4 \text{ A}$	-	0.018	0.022	Ω	
		$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	-	0.020	0.030	-	
		$V_{GS} = 1.2 \text{ V}, I_D = 1.3 \text{ A}$	-	0.025	0.075		
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 4 V, I_D = 7.2 A$	-	75	-	S	
Dynamic <sup>b</sup>			•		•	•	
Input capacitance	C <sub>iss</sub>		-	1070	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 4 V$ , $V_{GS} = 0 V$ , $f = 1 MHz$	-	385	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	200	-		
· · · · · ·		$V_{DS} = 4 V$ , $V_{GS} = 4.5 V$ , $I_{D} = 7.2 A$	-	10.5	15.8	nC	
Total gate charge	Qg		-	6	9		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 4 V$ , $V_{GS} = 2.5 V$ , $I_D = 7.2 A$	-	1.6	-		
Gate-drain charge	Q <sub>gd</sub>		-	1	-		
Gate resistance	Rg	f = 1 MHz	2.4	12	24	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	6	12		
Rise time	t <sub>r</sub>	$V_{DD} = 4 V, R_{L} = 0.7 \Omega,$	-	14	20	- ns	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \ \Omega$	-	65	98		
Fall time	t <sub>f</sub>		-	25	38		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	2.1	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	30	A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S} = 5.8$ A, $V_{\rm GS} = 0$	-	0.82	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	40	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 5.8 A, di/dt = 100 A/μs,	-	17	26	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 \ ^{\circ}C$	-	15	-		
Reverse recovery rise time	t <sub>b</sub>		-	25	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

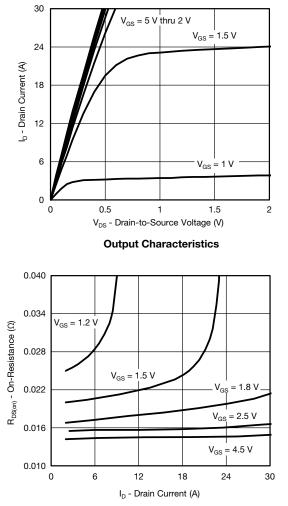
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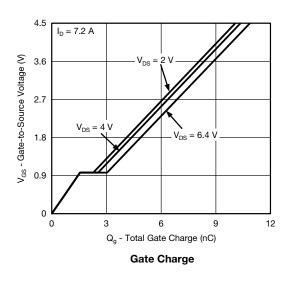


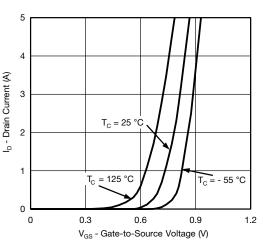
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

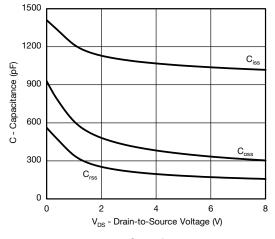


**On-Resistance vs. Drain Current and Gate Voltage** 

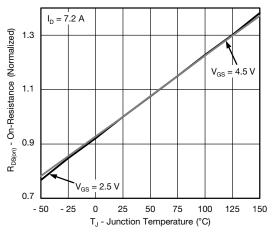




Transfer Characteristics



Capacitance



**On-Resistance vs. Junction Temperature** 

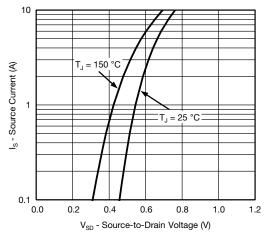
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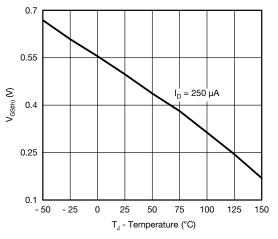


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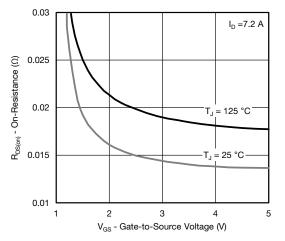
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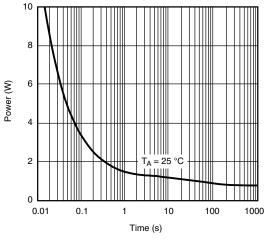
Source-Drain Diode Forward Voltage



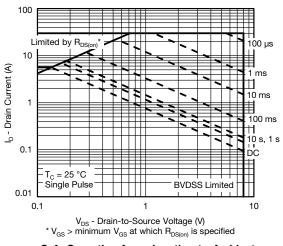
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power (Junction-to-Ambient)



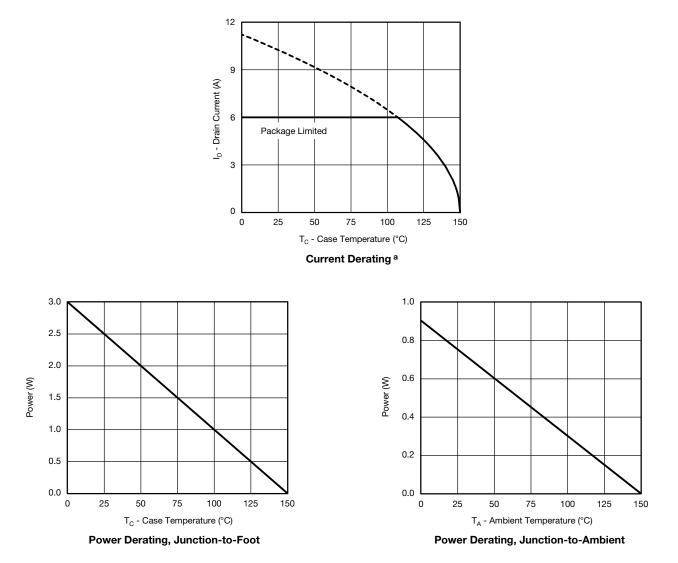
Safe Operating Area, Junction-to-Ambient

4



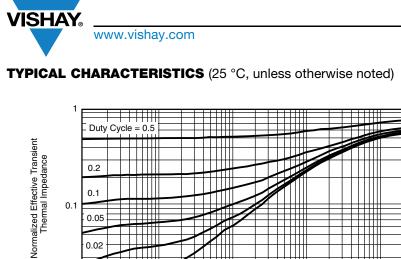
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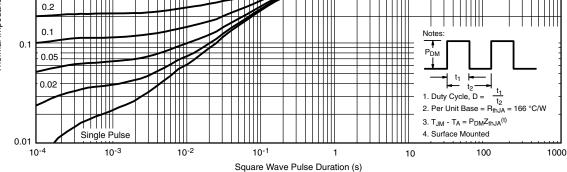
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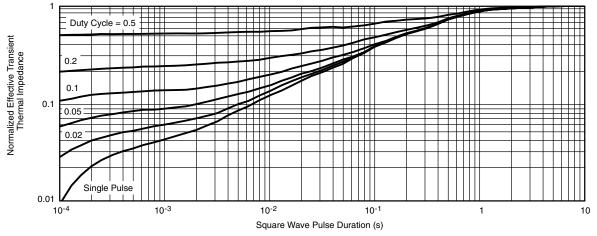
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63302.

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# Package Information

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#### SOT-23 (TO-236): 3-LEAD







Dim MiL Min	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# Application Note 826

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#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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